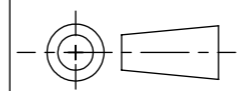


ISOMETRIC VIEW FOR REFERENCE

ITEM NUMBER	PART NUMBER	DESCRIPTION	QTY.
01	iW-PREPZ-MP-02-R3.0-REL1.1-HS001	SODIMM HEATSINK	01
02	LABEL	LABEL	01
03	TIM-23mm x 23mm	THERMAL PAD	01
04	TIM-8mm x 8mm	THERMAL PAD	01
05	M2 x6 X REC PAN HEAD SCREW	SCREW	04

DRAWN BY	GANGADHAR		iWave System Technologies Private Limited, 7/B, 29th Main, BTM Layout, 2nd Stage, Bangalore-560076, India.	
CHECKED BY	GANGADHAR			
APPROVED BY	IMMANUEL	DRAWING NO: iW-PREPZ-02-MA-R3.0-REL1.1		
THIS DRAWING SHEET IS PROPERITORY OF IWAVE SYSTEMS TECHNOLOGIES Pvt. Ltd.		MATERIAL :		WEIGHT: In grams.
		FINISH :		SUR AREA: In sqr.mm
GENARALTOLERANCES : X: ± 0.25 .X: ± 0.1 .XX: ± 0.01		TITLE: HEAT SINK AND TIM ASSEMBLY		REV: 1.1
NOTES: ALL DIMENSIONS ARE IN MM. ROUND OFF ALL SHARP EDGES. SCALE:		DATE : 15-05-2018		REL: 3.0
				SHEET 1 OF 1



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